



# Product Change Notification

**Change Notification #:** 115250 - 00  
**Change Title:** Intel® Server System R1304WT2GSR,  
PCN 115250-00, Product Design,  
Top Cover Screw Removal  
**Date of Publication:** January 12, 2017

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	Jan 17, 2017
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel will remove the Screw from the Top Cover of the Intel® Server System R1304WT2GSR to provide tool-less assembly

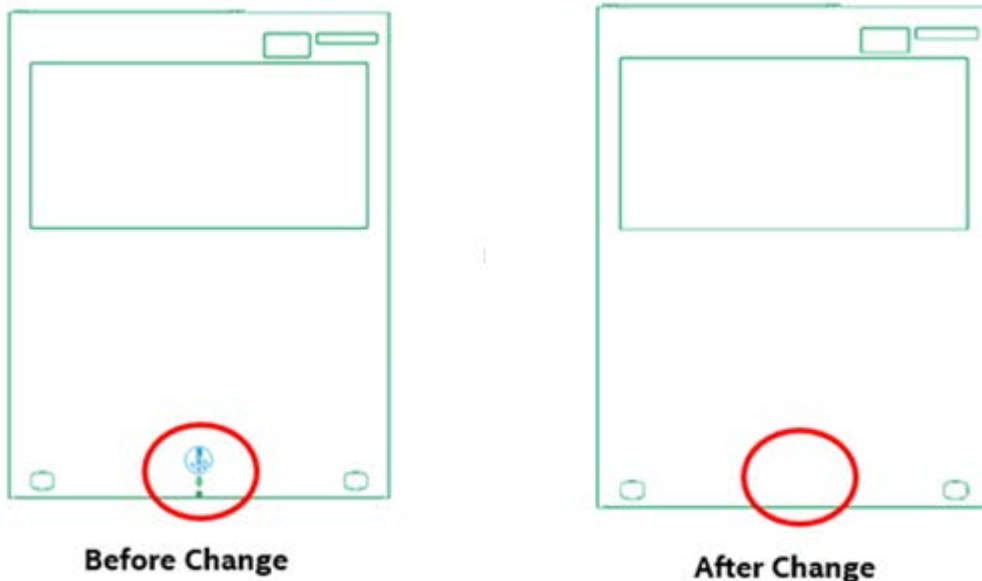


Figure 1. Remove the screw from the top cover

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304WT2GSR	943892	J11483-003	J11483-004

## PCN Revision History:

**Date of Revision:**

January 12, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

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